

Axial-Lead Glass Passivated Standard Recovery Rectifiers

1N5400 thru 1N5408

Lead mounted standard recovery rectifiers are designed for use in power supplies and other applications having need of a device with the following features:

Features

- High Current to Small Size
- High Surge Current Capability
- Low Forward Voltage Drop
- Void-Free Economical Plastic Package
- Available in Volume Quantities
- Plastic Meets UL 94 V-0 for Flammability
- These are Pb-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Indicated by Polarity Band

STANDARD RECOVERY RECTIFIERS 50–1000 VOLTS 3.0 AMPERES



AXIAL LEAD CASE 267-05 STYLE 1

MARKING DIAGRAM



A = Assembly Location 1N540x = Device Number x = 0, 1, 2, 4, 6, 7 or 8

YY = Year WW = Work Week Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

| Rating | Symbol | 1N5400 | 1N5401 | 1N5402 | 1N5404 | 1N5406 | 1N5407 | 1N5408 | Unit |
|--|--|------------------------------|--------|--------|--------|--------|--------|--------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Non-repetitive Peak Reverse Voltage | V _{RSM} | 100 | 200 | 300 | 525 | 800 | 1000 | 1200 | V |
| Average Rectified Forward Current (Single Phase Resistive Load, 1/2 in. Leads, T _L = 105°C) | lo | | 3.0 | | | | А | | |
| Non-repetitive Peak Surge Current (8 ms Single Half-Sine-Wave) | I _{FSM} | 200 (one cycle) | | | | Α | | | |
| Operating and Storage Junction Temperature Range | T _J T _{stg} | – 65 to +150 – 65 to +175 | | | | °C | | | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Тур | Unit |
|---|-----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient (PC Board Mount, 1/2 in. Leads) | $R_{\theta JA}$ | 53 | °C/W |

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|----------------|-----|-----|----------|------|
| Forward Voltage (I _F = 3.0 A, T _A = 25°C) | ٧ _F | - | _ | 1.0 | V |
| Reverse Current (Rated DC Voltage) $T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$ | I _R | - | - | 10 50 | μΑ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Ratings at 25°C ambient temperature unless otherwise specified.

60 Hz resistive or inductive loads.

For capacitive load, derate current by 20%.

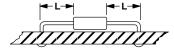
NOTE 1 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction–to–ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

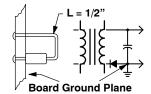
TYPICAL VALUES FOR $\textbf{R}_{\theta \text{JA}}$ IN STILL AIR

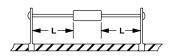
| Mounting | Lead Length, L (IN) | | | | $R_{\theta JA}$ | |
|----------|---------------------|-----|-----|-----|-----------------|--|
| Method | 1/8 | 1/4 | 1/2 | 3/4 | 0271 | |
| 1 | 50 | 51 | 53 | 55 | °C/W | |
| 2 | 58 | 59 | 61 | 63 | °C/W | |
| 3 | 28 | | | | °C/W | |

MOUNTING METHOD 1 P.C. Board Where Available Copper Surface area is small MOUNTING METHOD 3 P.C. Board with 1-1/2" x 1-1/2" Copper Surface



MOUNTING METHOD 2 Vector Push-In Terminals T-28





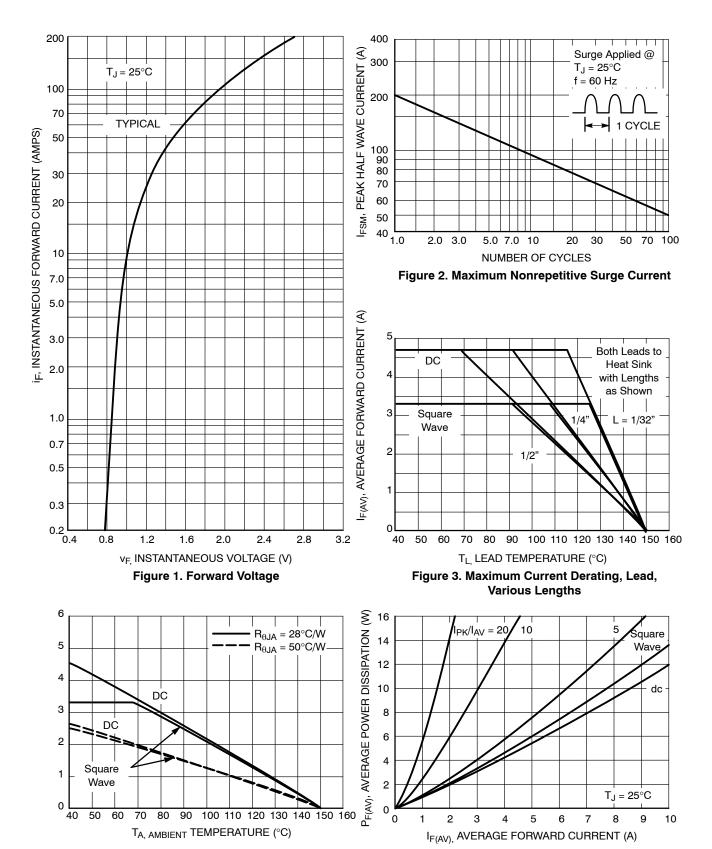
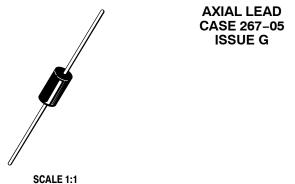


Figure 4. Maximum Current Derating, Ambient, PC
Board Mounting

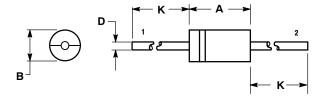
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------|-------------|-----------------------|
| 1N5400G | Axial Lead* | 500 Units/Box |
| 1N5400RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5401G | Axial Lead* | 500 Units/Box |
| 1N5401RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5402G | Axial Lead* | 500 Units/Box |
| 1N5402RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5404G | Axial Lead* | 500 Units/Box |
| 1N5404RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5406G | Axial Lead* | 500 Units/Box |
| 1N5406RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5407G | Axial Lead* | 500 Units/Box |
| 1N5407RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5408G | Axial Lead* | 500 Units/Box |
| 1N5408RLG | Axial Lead* | 1200/Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*This package is inherently Pb-Free.



DATE 06/06/2000



- NOTES:

 1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

 3. 267-04 OBSOLETE, NEW STANDARD 267-05.

| | INCHES | | MILLIN | IETERS |
|-----|--------|-------|--------|--------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.287 | 0.374 | 7.30 | 9.50 |
| В | 0.189 | 0.209 | 4.80 | 5.30 |
| D | 0.047 | 0.051 | 1.20 | 1.30 |
| K | 1.000 | | 25 40 | |

STYLE 2: NO POLARITY STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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|------------------|-------------|--|-------------|--|--|
| DESCRIPTION: | AXIAL LEAD | | PAGE 1 OF 1 | | |

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ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

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<u>1N5404 1N5400 1N5400G 1N5400RL 1N5400RLG 1N5401 1N5401G 1N5401RL 1N5401RLG 1N5402</u> <u>1N5402G 1N5402RL 1N5402RLG 1N5404G 1N5404RL 1N5404RLG 1N5406 1N5406G 1N5406RL 1N5406RLG</u> 1N5407 1N5407G 1N5407RL 1N5407RLG 1N5408 1N5408G 1N5408RL 1N5408RLG 1N5401_Q 1N5408_Q